# BGF104 HSMMC Interface Filter and ESD Protection

## Small Signal Discretes



Never stop thinking

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### **BGF104**

Revision History: 2006-10-17, V2.1

Previous Version: 2006-03-03

Page	Subjects (major changes since last revision)				
All	Layout conformation				



### HSMMC Interface Filter and ESD Protection

**BGF104** 

### HSMMC Interface Filter and ESD Protection

### Feature

- ESD protection and filter for High Speed Multi Media Card interface
- ESD protection up to 15 kV at the external IOs
- 16 pin green wafer level package with SnAgCu solder balls
- 500 μm solder ball pitch
- 300 µm solder ball diameter







Figure 1 Blockdiagram

### Description

The BGF104 is an ESD protection and filter circuit for a high speed multi media card interface. External pins are protected up to 15 kV contact discharge according to IEC61000-4-2. The wafer level package is a green package with a size of only 1.96 mm x 1.96 mm and a total height of 0.65 mm.

Туре	Package	Marking	Chip
BGF104	WLP-16-1	BGF104	N0708



### **HSMMC Interface Filter and ESD Protection**

### Table 1 Maximum Ratings

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Voltage at all pins to GND	V <sub>P</sub>	-14		14	V	
Operating temperature range	T <sub>OP</sub>	-40		+85	°C	
Storage temperature range	T <sub>STG</sub>	-65		+150	°C	
Electrostatic Discharge According to IE	EC61000-4-2			<u>!</u>		I
Ext.IOs: A1, A2, A3, B1, B2, C1, D1	VE	-15		15	kV	
Int. IOs: A4, B4; C3, C4, D3, D4	VI	-2		2	kV	

### Table 2 Electrical Characteristics<sup>1)</sup>

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		<b>Test Condition</b>
Resistors $R_1R_6$	R <sub>16</sub>	40	50	60	Ω	
Resistors R <sub>7</sub> R <sub>10</sub>	R <sub>710</sub>	52.5	75	97.5	kΩ	
Resistor R <sub>11</sub>	<i>R</i> <sub>11</sub>	4.9	7	9.1	kΩ	
Reverse current of ESD protection diodes	I <sub>R</sub>		5 0.1	100 10	nA μA	$V_{\rm R}$ = 3 V $V_{\rm R}$ = 14V
Line capacitance Capacitance of each line to GND	C <sub>T</sub>		16	20	pF	<i>V</i> <sub>R</sub> = 0 V

1) at *T*<sub>A</sub> = 25 °C







### HSMMC Interface Filter and ESD Protection





Figure 4 Tape for WLP-16-1